Disciplinary Clearance Form

To be completed by the student applicant:

After completing the section below, please submit this form to your Judicial Affairs Office. By signing below, you consent to the release of this information to the American Junior Year Program or the Heidelberg at Heidelberg Summer Program in Heidelberg, Germany, as well as to Heidelberg University in Tiffin, Ohio.

Name of Applicant: ____________________________________

Signature of Applicant: ____________________________________

Home Campus: ___________________________ Semester/Year of study: ____________

To be completed by a member of the Student’s Judicial Affairs Office:

The student named above has applied to participate in the American Junior Year Program or the Heidelberg at Heidelberg Summer Program in Heidelberg, Germany. We would appreciate a confidential statement regarding this student’s record at your institution. A prior disciplinary history will not automatically preclude the participation of a student in our program. Nonetheless, information relating to this student’s judicial affairs history will be taken into consideration in making the final decision regarding participation. Please return this form at your earliest convenience by fax or to the address above.

☐ This student has no history of judicial sanction.

☐ This student has a history of/is currently under judicial sanction(s).

Please explain below:

________________________________________________________________________

________________________________________________________________________

RECOMMENDATION

In regard to the prospect of having this student participate in a semester or year of study at the University of Heidelberg, I have

☐ strong reservations ☐ some reservations, but still recommend participation

☐ no reservations

Signature of Judicial Affairs Official ________________________________

Printed Name ________________________________

Title ________________________________ Institution ________________________________

Telephone ________________________________ Date ________________________________